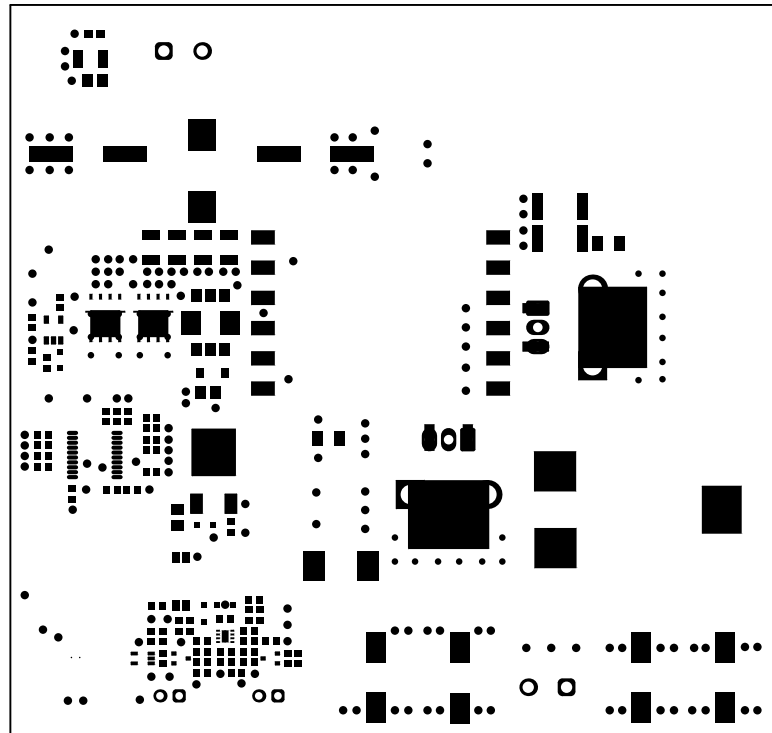
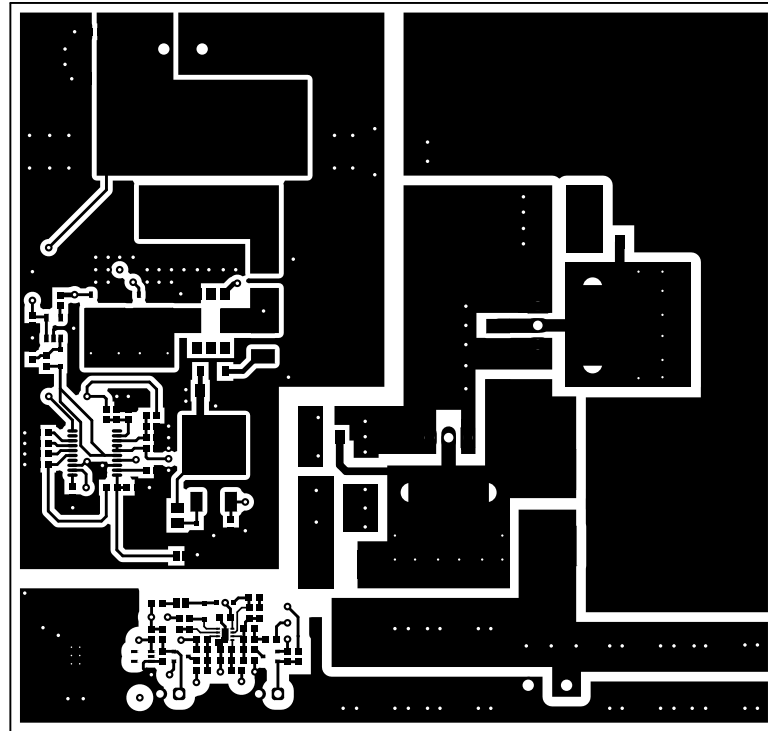


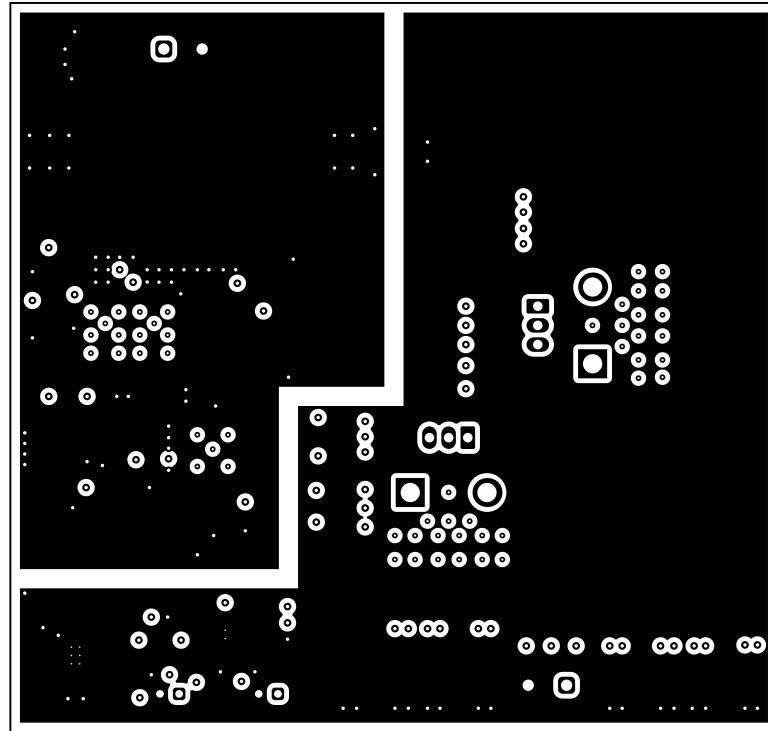
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 4/18/2022 12:05:48 PM	TEXAS INSTRUMENTS	



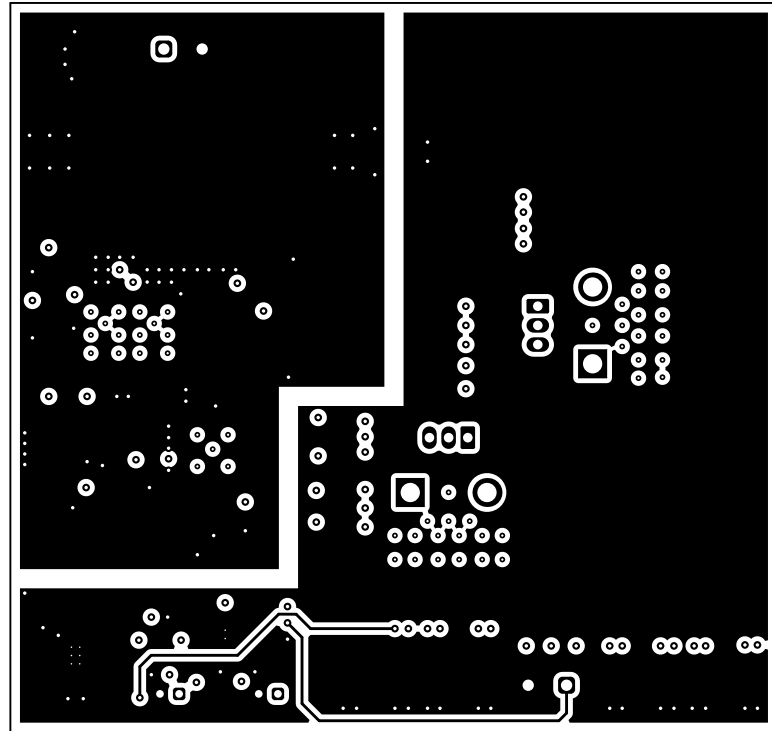
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 4/18/2022 12:05:48 PM	TEXAS INSTRUMENTS	



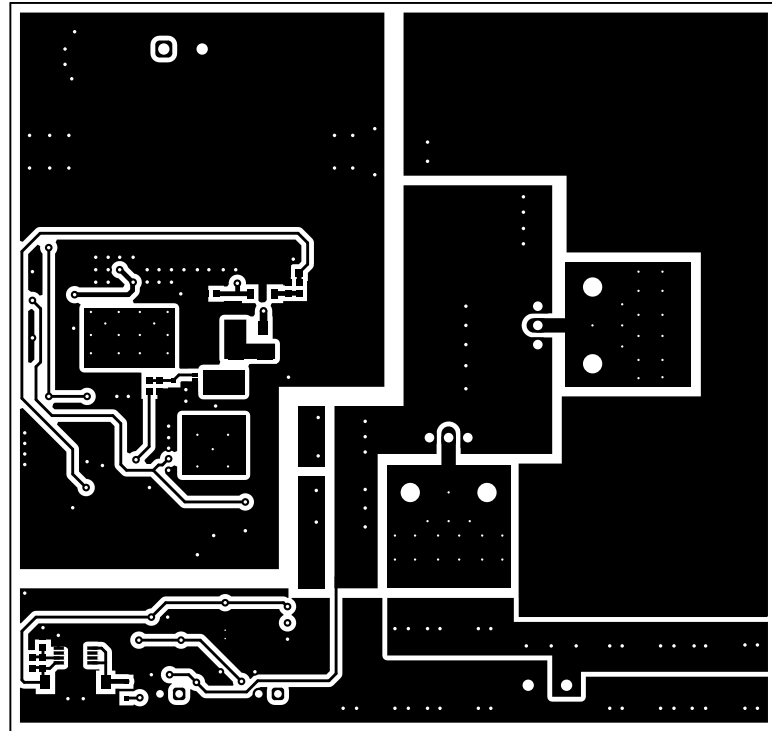
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 4/18/2022 12:05:48 PM	TEXAS INSTRUMENTS	



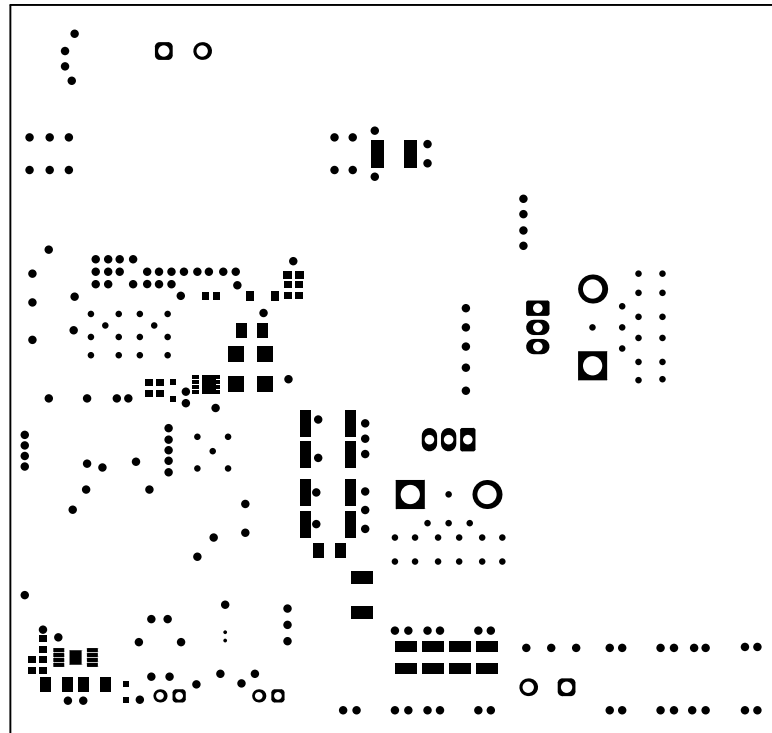
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal Layer 1	GENERATED : 4/18/2022 12:05:48 PM	TEXAS INSTRUMENTS	



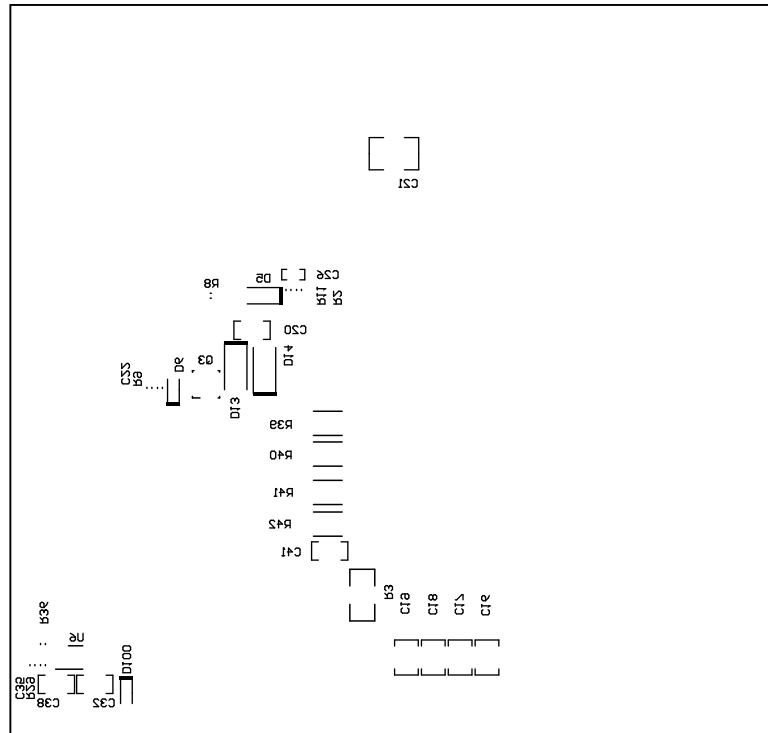
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME =	TID #: N/A		
PLOT NAME = Signal Layer 2	GENERATED : 4/18/2022 12:05:48 PM	TEXAS INSTRUMENTS	



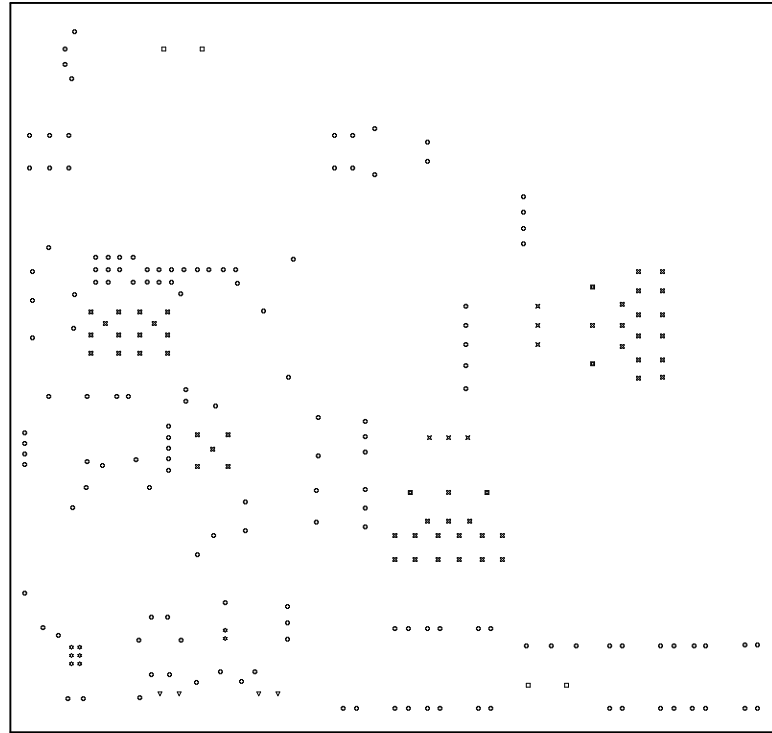
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 4/18/2022 12:05:49 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/18/2022 12:05:49 PM	TEXAS INSTRUMENTS	

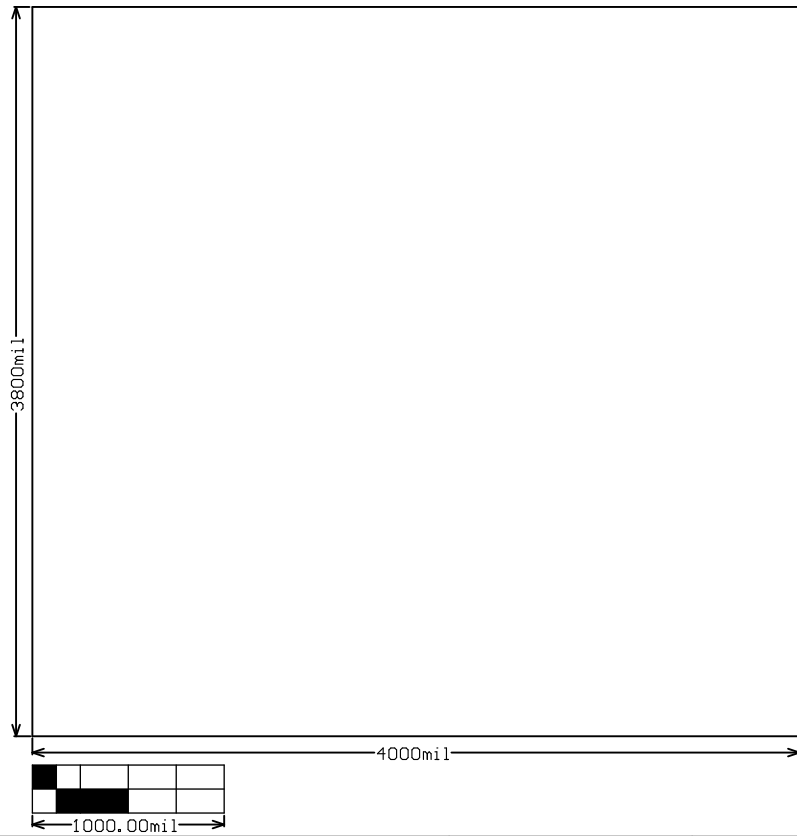


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 4/18/2022 12:05:49 PM	TEXAS INSTRUMENTS	



Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template
▽	4	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)
□	4	59.06mil (1.500mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)
■	4	100.39mil (2.550mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)
⊗	6	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)	(Mixed)
⊛	8	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	(Mixed)
⊗	51	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v76h30
⊛	148	18.00mil (0.457mm)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	v102h46
	225 Total							

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 4/18/2022 12:05:49 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP23123	REV: E	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 4/18/2022 12:05:50 PM	TEXAS INSTRUMENTS	

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